Ultra-Low Capacitance ESD Diode Array

- ESD / transient protection of high-speed data lines exceeding IEC61000-4-2 (ESD): 20 kV (air / contact) IEC61000-4-4 (EFT): 40 A (5/50 ns) IEC61000-4-5 (surge): 3 A ( $8 / 20 \mu \mathrm{~s}$ )
- Max. working voltage: 5.3 V
- Extremely low capacitance: down to 0.2 pF
- Very low clamping voltage: 12 V typ.

- Extremely low forward clamping voltage: 4 V typ.
- Very low reverse current: < 1 nA typ.
- Pb-free (RoHS compliant) package


## Applications

- USB 2.0, 10/100/1000 Ethernet, FireWire, DVI

HDMI, S-ATA

- Mobile communication
- Consumer products (STB, MP3; DVD, DSC...)
- LCD displays, camera
- Notebooks and destop computers, peripherals


## RoHS

ESD5V3U2U-03F
ESD5V3U2U-03LRH


| Type | Package | Configuration | Marking |
| :--- | :--- | :--- | :--- |
| ESD5V3U2U-03F | TSFP-3 | 2 lines, uni-directional* | Z1 |
| ESD5V3U2U-03LRH | TSLP-3-7 | 2 lines, uni-directional* | Z1 |

[^0]Maximum Ratings at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
| :--- | :--- | :---: | :--- |
| ESD contact/ air discharge ${ }^{1)}$ | $V_{\mathrm{ESD}}$ | 20 | kV |
| Peak pulse current $\left.\left(t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}\right)^{2}\right)$ | $I_{\mathrm{pp}}$ | 3 | A |
| Operating temperature range | $T_{\mathrm{op}}$ | $-40 \ldots 125$ | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $T_{\mathrm{stg}}$ | $-65 \ldots 150$ |  |

Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Characteristics - |  |  |  |  |  |
| Reverse working voltage | $V_{\text {RWM }}$ | - | - | 5.3 | V |
| Breakdown voltage $I_{(\mathrm{BR})}=1 \mathrm{~mA}$, from pin 1 to 3 | $V_{\text {(BR) }}$ | 6 | - | - |  |
| Reverse current $V_{\mathrm{R}}=5.3 \mathrm{~V}$, from pin 1 to 3 | $I_{R}$ | - | < 1 | 50 | nA |
| Clamping voltage $\begin{aligned} I_{\mathrm{PP}} & \left.=1 \mathrm{~A}, t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}^{2}\right), \text { from } 1 / 2 \text { to } 3 \\ I_{\mathrm{PP}} & \left.=3 \mathrm{~A}, t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}^{2}\right) \text {, from } 1 / 2 \text { to } 3 \end{aligned}$ | $V_{\text {CL }}$ | - | $\begin{aligned} & 10 \\ & 12 \end{aligned}$ | $\begin{aligned} & 13 \\ & 15 \end{aligned}$ | V |
| Forward clamping voltage $\begin{aligned} & \left.I_{\mathrm{PP}}=1 \mathrm{~A}, t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}^{2}\right), \text { from } 3 \text { to } 1 / 2 \\ & \left.I_{\mathrm{PP}}=3 \mathrm{~A}, t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}^{2}\right), \text { from } 3 \text { to } 1 / 2 \end{aligned}$ | $V_{\text {FC }}$ | - | $\begin{aligned} & 2 \\ & 4 \end{aligned}$ | $4$ |  |
| Line capacitance, $V_{\mathrm{R}}=0 \mathrm{~V}, f=1 \mathrm{MHz}$ from pin $1 / 2$ to $3^{3)}$ from pin 1 to 2 , pin 3 not connected | $C_{T}$ | - | $\begin{aligned} & 0.4 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | pF |

${ }^{1} V_{\text {ESD }}$ according to IEC61000-4-2
${ }^{2} / \mathrm{pp}$ according to IEC61000-4-5
${ }^{3}$ Total capacitance line to ground

Clamping voltage, $V_{c l}=f\left(l_{p p}\right)$
$t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}$, from pin $1 / 2$ to 3


Reverse current $I_{\mathrm{R}}=f\left(T_{\mathrm{A}}\right)$
$V_{R}=$ Parameter, from pin $1 / 2$ to 3


Forward clamping voltage $V_{\mathrm{FC}}=f\left(I_{\mathrm{PP}}\right)$ $t_{\mathrm{p}}=8 / 20 \mu \mathrm{~s}$, from pin 3 to $1 / 2$


Diode capacitance $C_{T}=f\left(\mathrm{~V}_{\mathrm{R}}\right)$
$f=1 \mathrm{MHz}$, from pin $1 / 2$ to 3


Line capacitance $C_{T}=f(f)$
$V_{\mathrm{R}}=$ parameter, from pin $1 / 2$ to 3


Line capacitance $C_{T}=f\left(T_{\mathrm{A}}\right)$
$V_{\mathrm{R}}=0 \mathrm{~V}, f=1 \mathrm{MHz}$


## Application example ESD5V3U2U... <br> 2 lines, uni-directional



## Application example ESD5V3U2U...

1 line, bi-directional


Package Outline


Foot Print


Marking Layout (Example)


Standard Packing
Reel $\varnothing 180 \mathrm{~mm}=3.000$ Pieces/Reel
Reel $\varnothing 330 \mathrm{~mm}=10.000$ Pieces/Reel


Package Outline

## Foot Print

For board assembly information please refer to Infineon website "Packages"



Stencil apertures

## Marking Layout



Standard


Only for diodes, cathode marking on pin 3

## Standard Packing

Reel $\varnothing 180 \mathrm{~mm}=15.000$ Pieces/Reel


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[^0]:    * or 1 line, bi-directional between pins 1 and 2 , if pin 3 is not connected

